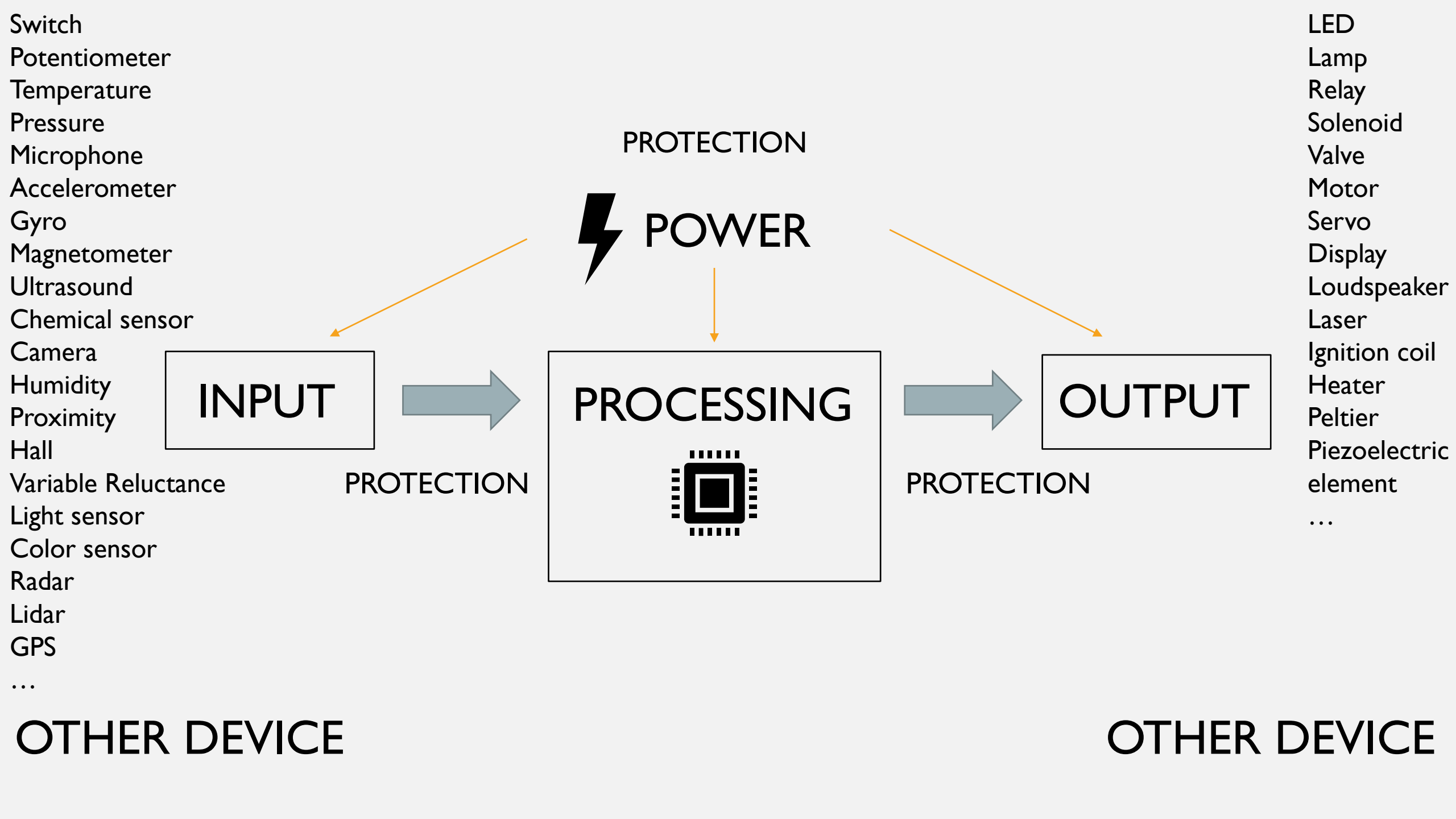
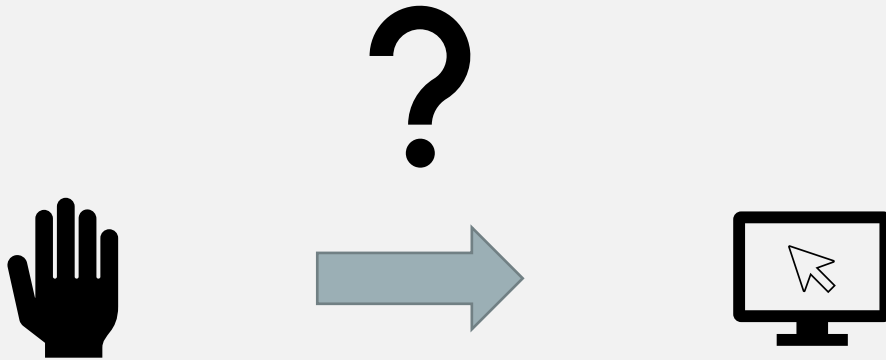


E7020e

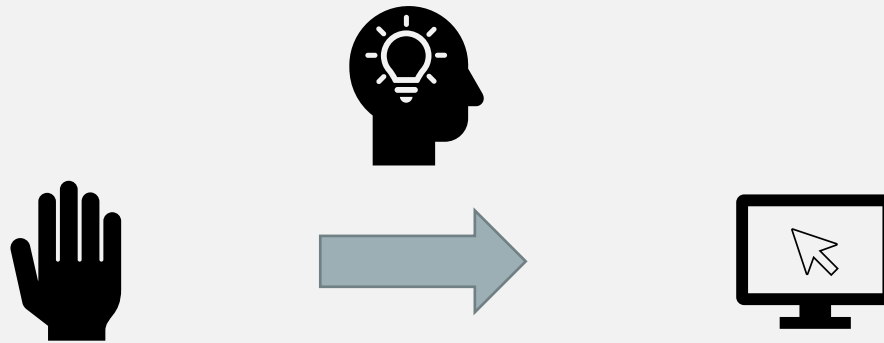
# HARDWARE



# PROBLEM

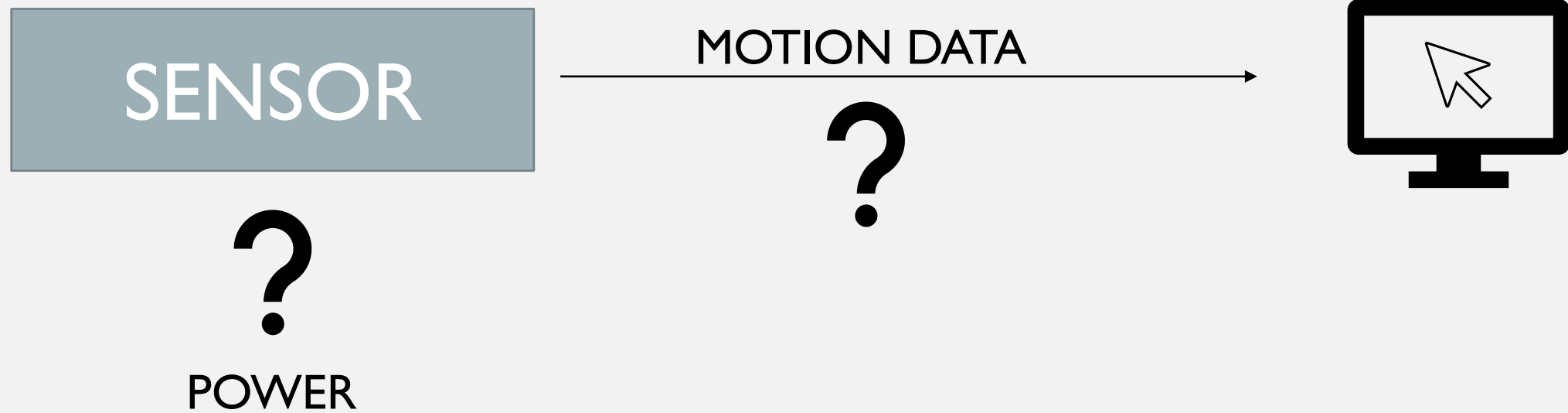


# PROBLEM

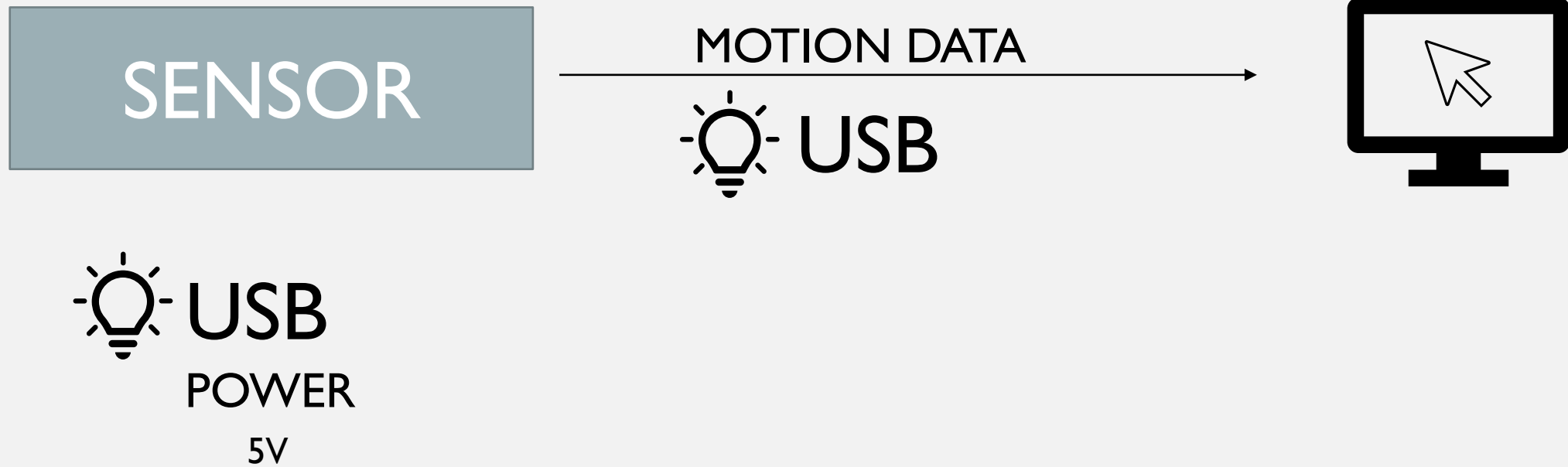


MOTION SENSOR

# BLOCK DIAGRAM



# BLOCK DIAGRAM



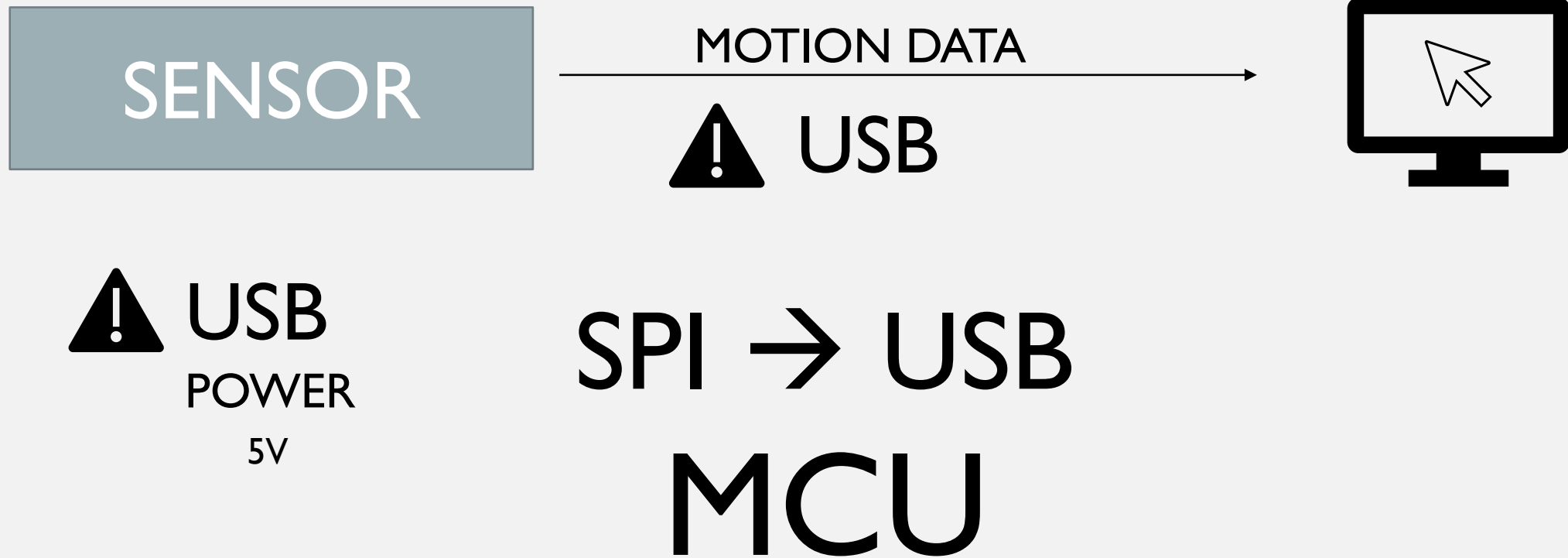
# SENSOR

## PMW3389

System-on-a-Chip (SoC)  
IR LED + Camera + DSP  
SPI communication



# BLOCK DIAGRAM







”Single chip computer”

CPU

Memory

Peripherals

GPIO

# GPIO

”General purpose input/output”

Voltage levels to represent bits/booleans

Tri-state: Low/Hi/Hi-Z (floating)

INPUTS:

Active low / active high

Pull up/down resistors (/internal)

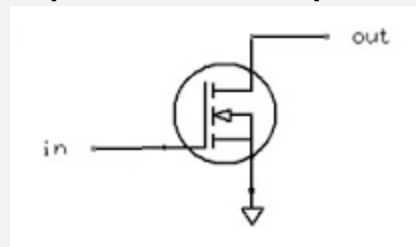
OUTPUTS:

Push-pull

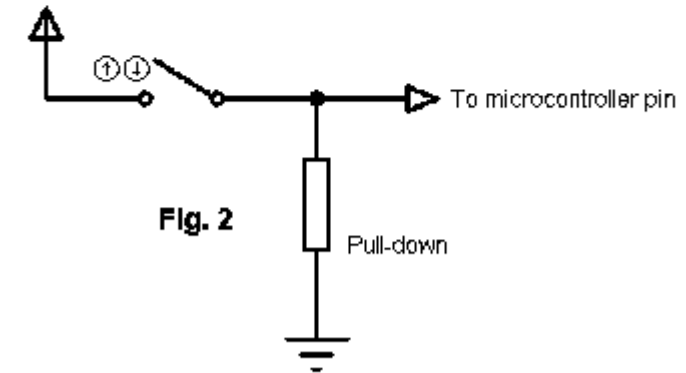
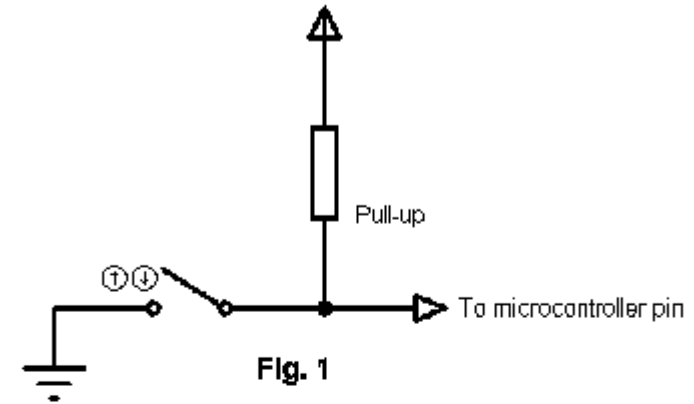
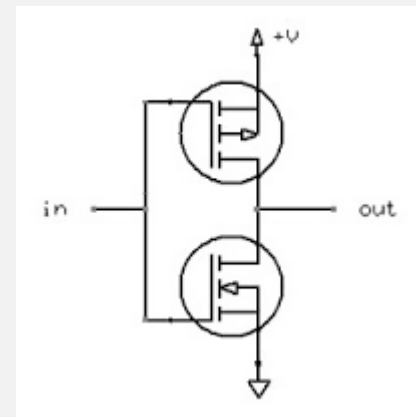
Open drain

Pull-up resistor

Open drain output



Push-pull output  
("totem-pole")



# GPIO

## RATINGS

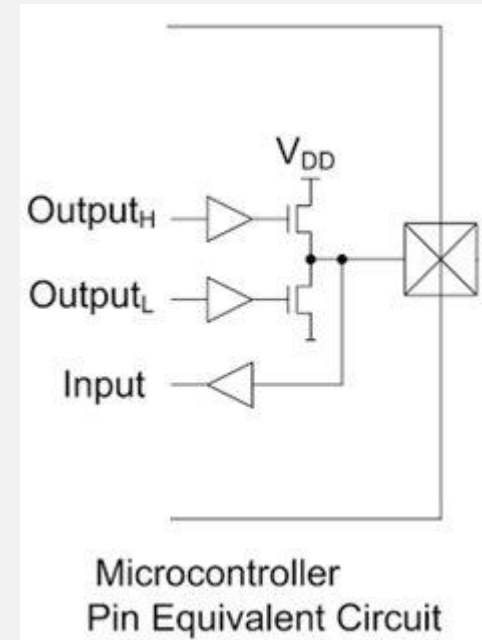
Max current (sink/source)

Max voltage (5v tolerant?)

Input/output resistance

Capacitance

Rise/fall time



# GPIO

Associated special functionality  
Peripherals

”INTERFACES TO OUTSIDE WORLD”

- UART / SERIAL
- SPI
- I2C
- USB
- TIMER
- PWM
- QUADRATURE DECODER
- ...

Table 9. Alternate function mapping																
Port	AF00	AF01	AF02	AF03	AF04	AF05	AF06	AF07	AF08	AF09	AF10	AF11	AF12	AF13	AF14	AF15
	SYS_AF	TIM1/TIM2	TIM3/ TIM4/ TIM5	TIM9/ TIM10/ TIM11	I2C1/I2C2/ I2C3	SPI1/SPI2/ I2S2/SPI3/ I2S3/SPI4	SPI2/I2S2/ SPI3/ I2S3	SPI3/I2S3/ USART1/ USART2	USART6	I2C2/ I2C3	OTG1_FS		SDIO			
Port A	PA0	-	TIM2_CH1/ TIM2_ETR	TIM5_CH1	-	-	-	USART2_ CTS	-	-	-	-	-	-	-	EXTI_0
	PA1	-	TIM2_CH2	TIM5_CH2	-	-	-	USART2_ RTS	-	-	-	-	-	-	-	EXTI_1
	PA2	-	TIM2_CH3	TIM5_CH3	TIM9_CH1	-	-	USART2_ TX	-	-	-	-	-	-	-	EXTI_2
	PA3	-	TIM2_CH4	TIM5_CH4	TIM9_CH2	-	-	USART2_ RX	-	-	-	-	-	-	-	EXTI_3
	PA4	-	-	-	-	SPI1_NSS	SPI3_NSS/ I2S3_WS	USART2_ CK	-	-	-	-	-	-	-	EXTI_4
	PA5	-	TIM2_CH1/ TIM2_ETR	-	-	SPI1_SCK	-	-	-	-	-	-	-	-	-	EXTI_5
	PA6	-	TIM1_BKIN	TIM3_CH1	-	-	SPI1_ MISO	-	-	-	-	-	-	-	-	EXTI_6
	PA7	-	TIM1_CH1N	TIM3_CH2	-	-	SPI1_ MOSI	-	-	-	-	-	-	-	-	EXTI_7
	PA8	MCO_1	TIM1_CH1	-	-	I2C3_SCL	-	-	USART1_ CK	-	-	OTG_FS_ SOF	-	-	-	EXTI_8
	PA9	-	TIM1_CH2	-	-	I2C3_ SMBA	-	-	USART1_ TX	-	-	OTG_FS_ VBUS	-	-	-	EXTI_9
	PA10	-	TIM1_CH3	-	-	-	-	USART1_ RX	-	-	OTG_FS_ ID	-	-	-	-	EXTI_10
	PA11	-	TIM1_CH4	-	-	-	-	USART1_ CTS	USART6_ TX	-	OTG_FS_ DM	-	-	-	-	EXTI_11
	PA12	-	TIM1_ETR	-	-	-	-	USART1_	USART6_	-	OTG_FS_	-	-	-	-	EXTI_12

# MCU

STM32F411  
ARM Cortex M4F  
SPI Peripheral  
USB PHY



# STM32F411

STM CubeMX Software

SPI

SCK

MISO

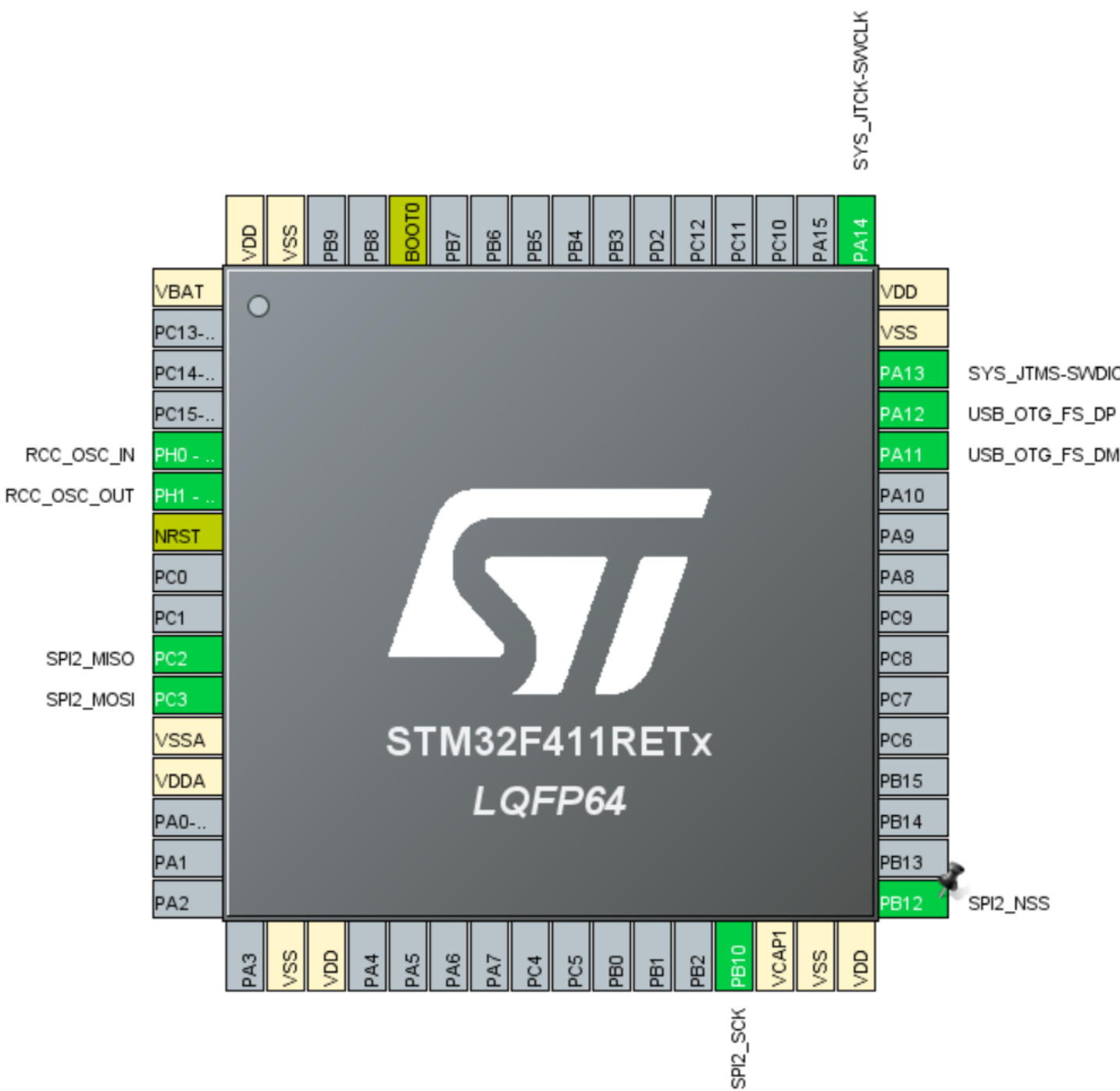
MOSI

NCS

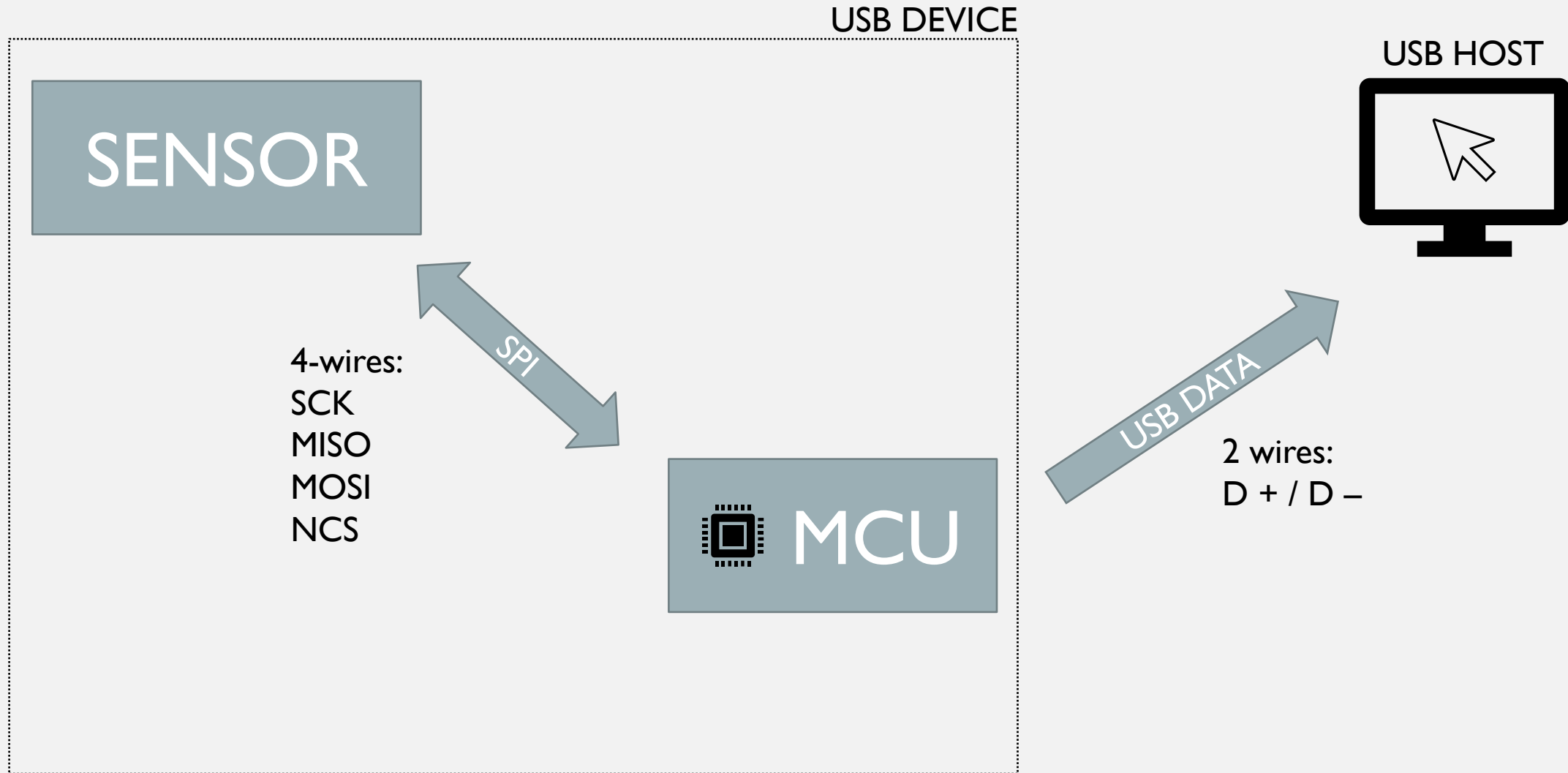
USB

D+

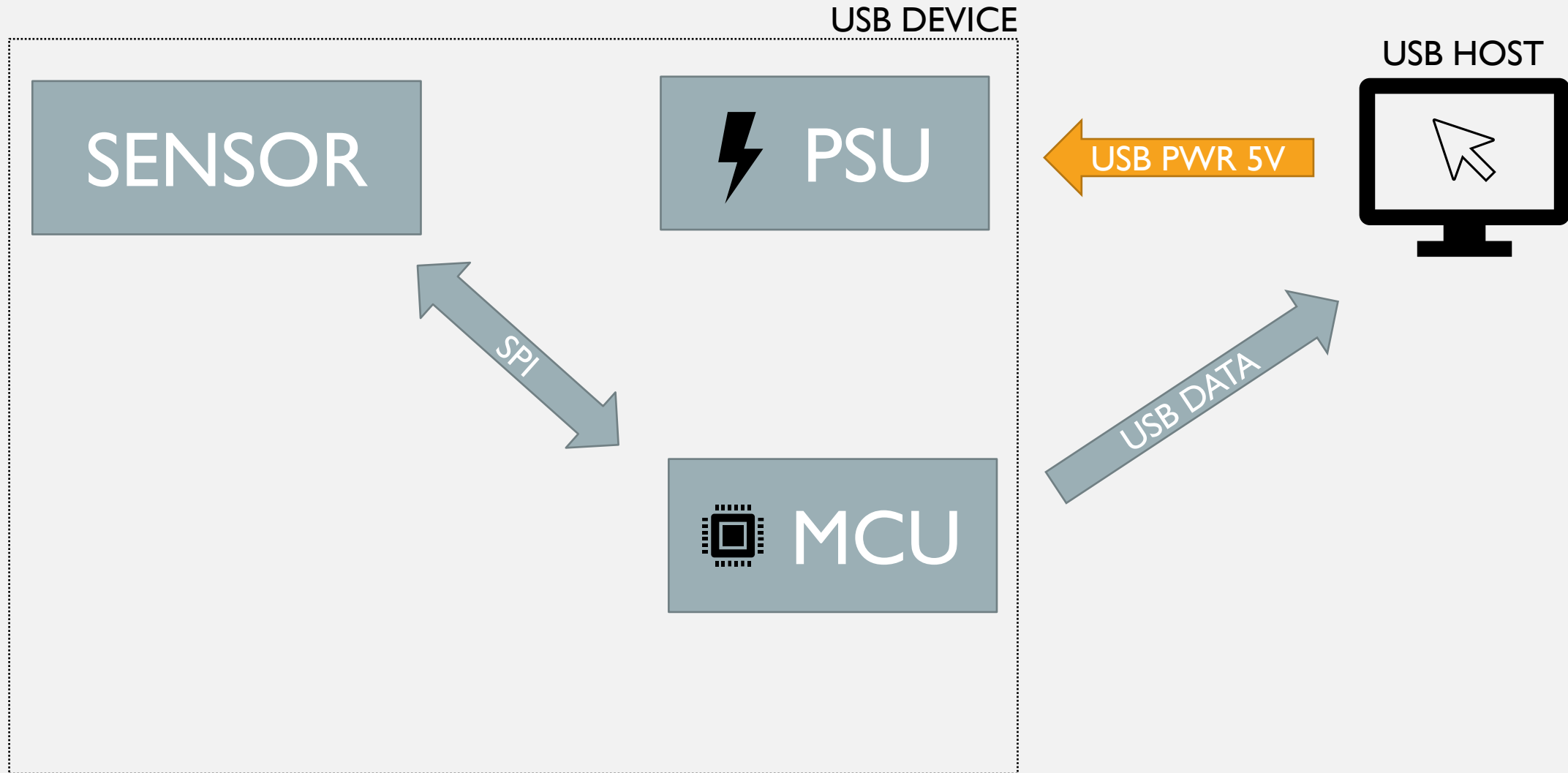
D-



## BLOCK DIAGRAM

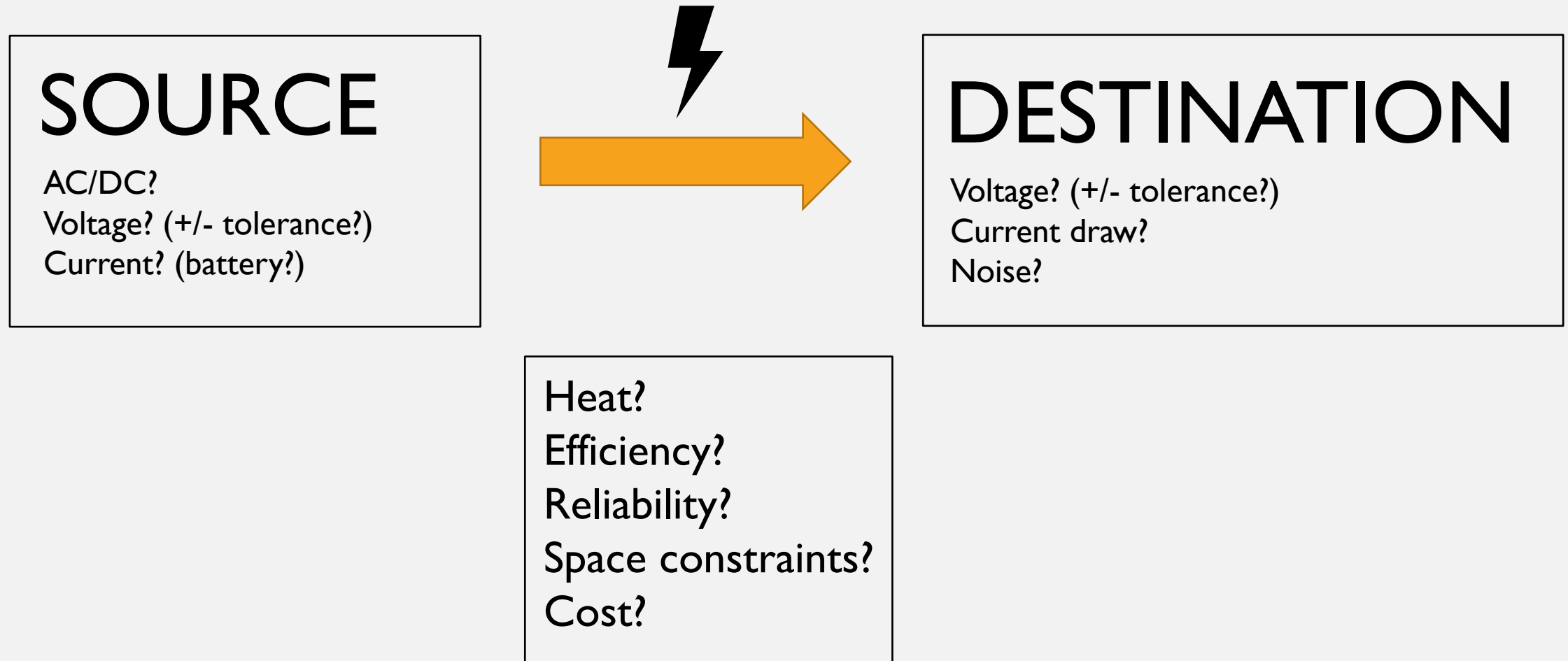


# BLOCK DIAGRAM





# POWER SUPPLY UNIT (PSU)



# POWER SUPPLY UNIT (PSU) VOLTAGE REGULATORS

LINEAR REGULATOR  
SWITCHING REGULATOR

# POWER SUPPLY UNIT (PSU) LINEAR REGULATOR

”3-terminal” device (in, out, ref)  
Fixed/adjustable output voltage

$V_{in} \geq V_{out} + V_{dropout}$   
Low dropout regulator (LDO)

PROS:

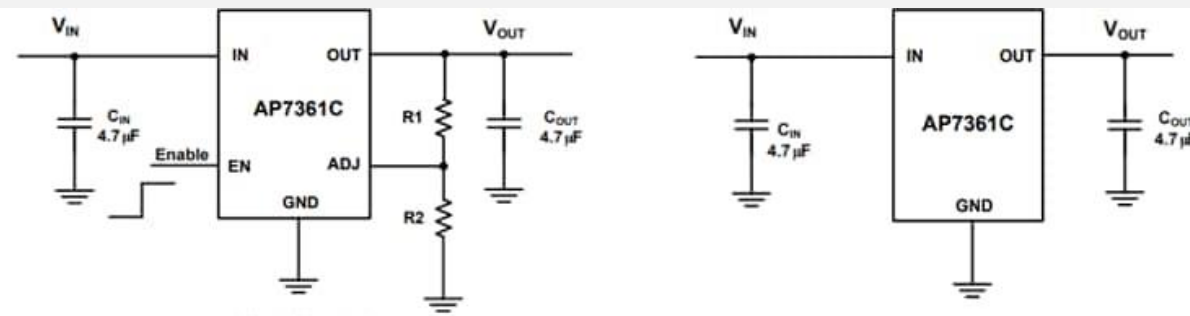
Low noise

Good line/load regulation

Cheap

CONS:

Excess voltage → HEAT



# POWER SUPPLY UNIT (PSU) SWITCHING REGULATOR

BUCK (higher voltage → lower voltage)

BOOST (lower voltage → higher voltage)

INVERTING

Transistor as switch → Low loss

PROS:

(Generally) higher efficiency

”trades voltage for current”

Can provide ISOLATION

Can generate INVERTED voltage

CONS:

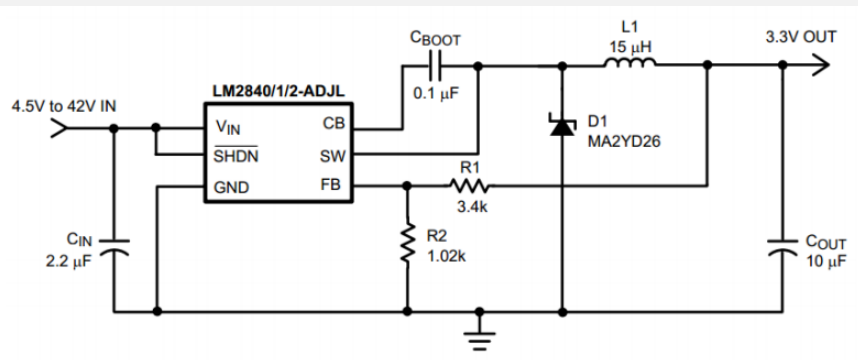
More complicated

(ready-made on-board-modules available)

Higher ripple/noise (LC filtering)

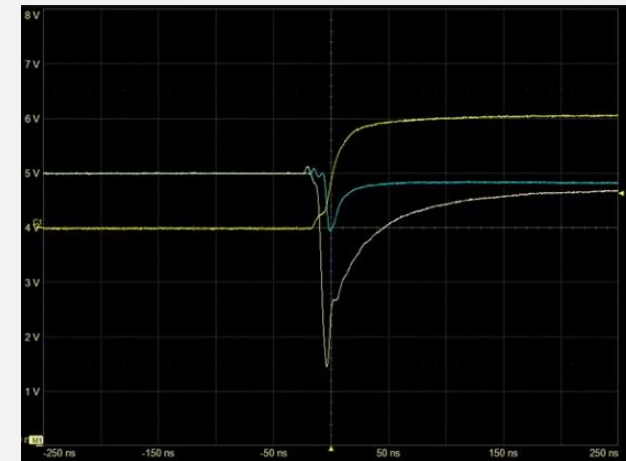
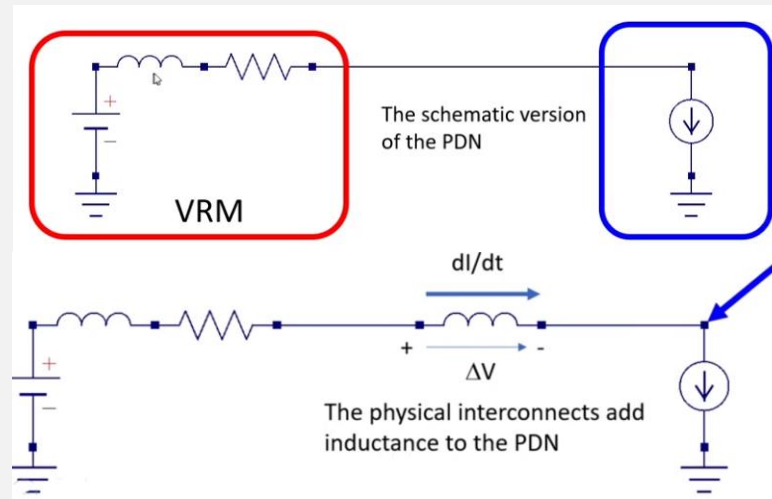
EMI

Load regulation



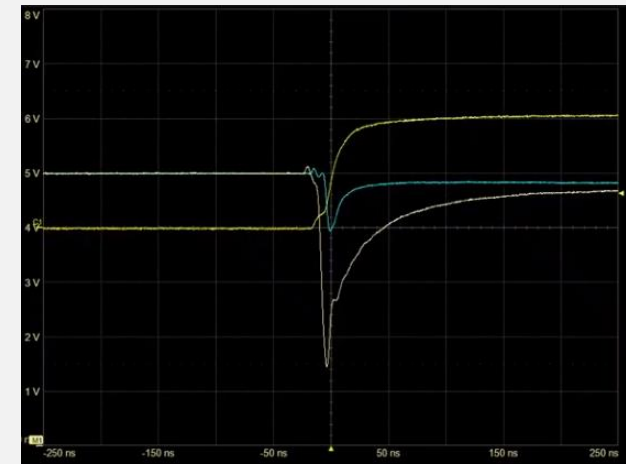
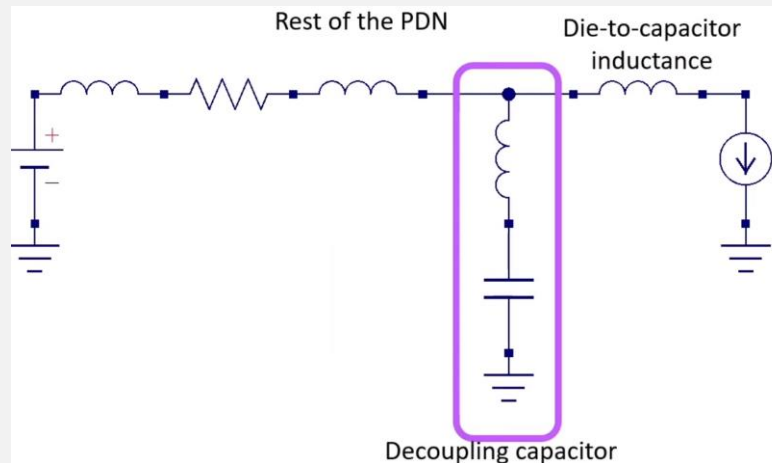
## POWER DISTRIBUTION NETWORK DECOUPLING

LOW INDUCTANCE POWER SOURCE  
STABLE SUPPLY VOLTAGE  
PREVENT UNDEFINED BEHAVIOUR



## POWER DISTRIBUTION NETWORK DECOUPLING

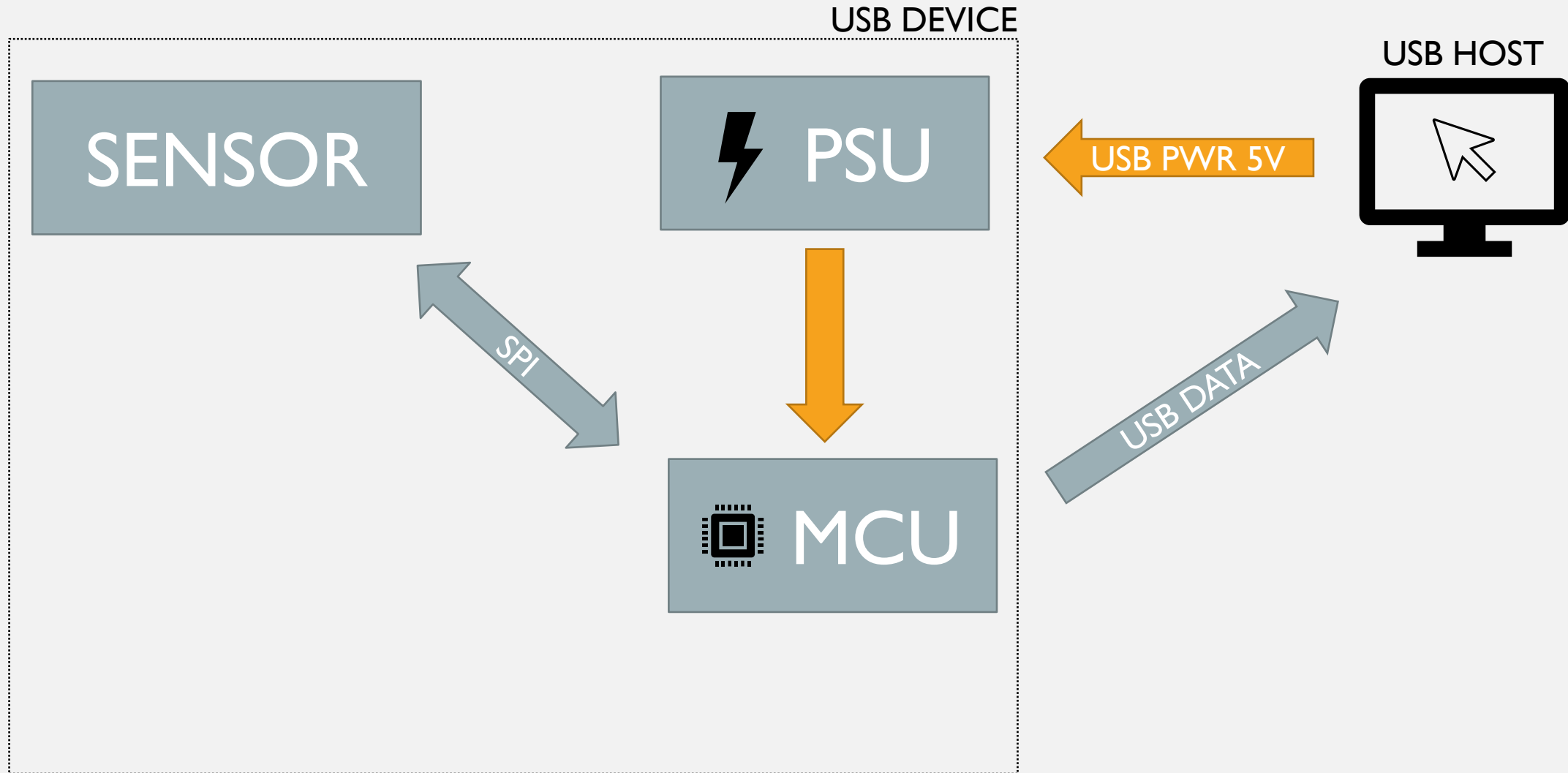
LOW INDUCTANCE POWER SOURCE  
STABLE SUPPLY VOLTAGE  
PREVENT UNDEFINED BEHAVIOUR



LOW INDUCTANCE  
"Large enough" capacitance

$$C > \frac{\Delta Q}{\Delta V} = \frac{I \Delta t}{\Delta V}$$

# BLOCK DIAGRAM



# POWER SUPPLY UNIT (PSU)

DESTINATION 1: MCU

**STM32F4II**

$V_{dd} = 1.7 - 3.6V$

$I(\text{max}) = 160\text{mA}$

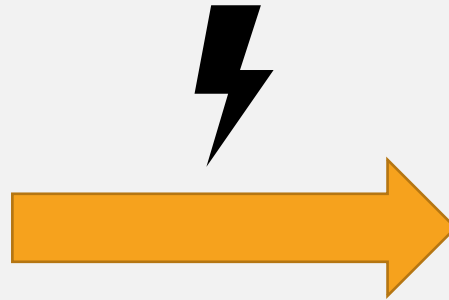
**$= 3.3V$**



# POWER SUPPLY UNIT (PSU)

## SOURCE

AC/DC?  
Voltage? (+/- tolerance?)  
Current? (battery?)



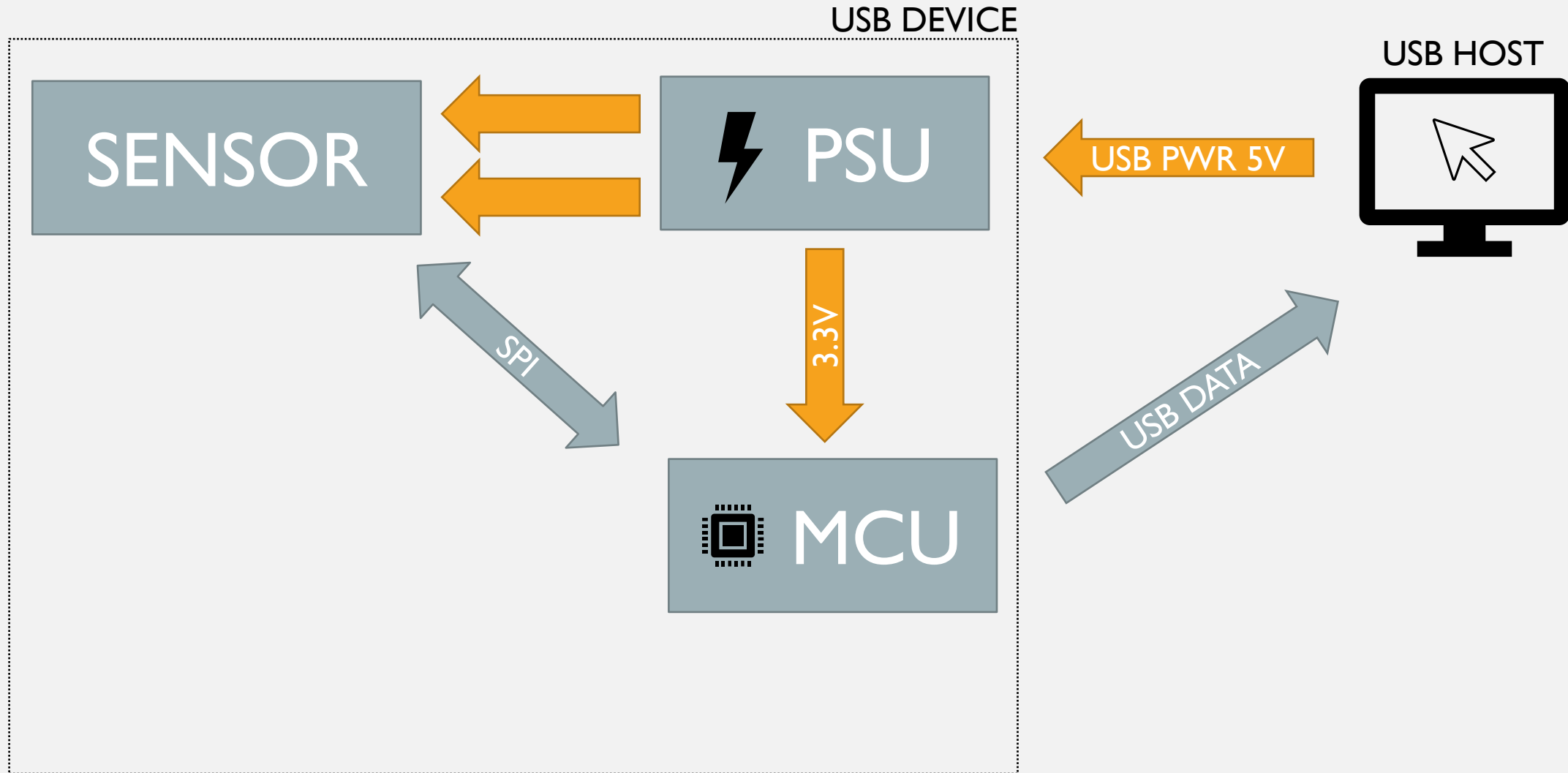
## DESTINATION

Voltage? (+/- tolerance?)  
Current draw?  
Noise?

Heat?  
Efficiency?  
Reliability?  
Space constraints?  
Cost?

# LDO

# BLOCK DIAGRAM



# POWER SUPPLY UNIT (PSU)

DESTINATION 2: SENSOR SoC

**PMW3389**

$V_{ddio} = 1.8 - 3.6V$

**$= 3.3V$**

$V_{dd} = 1.8 - 2.1V$

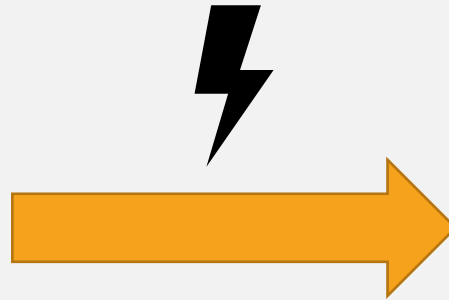
$I(\text{max}) = 21mA$

**$= 1.9V$**

# POWER SUPPLY UNIT (PSU)

## SOURCE

AC/DC?  
Voltage? (+/- tolerance?)  
Current? (battery?)



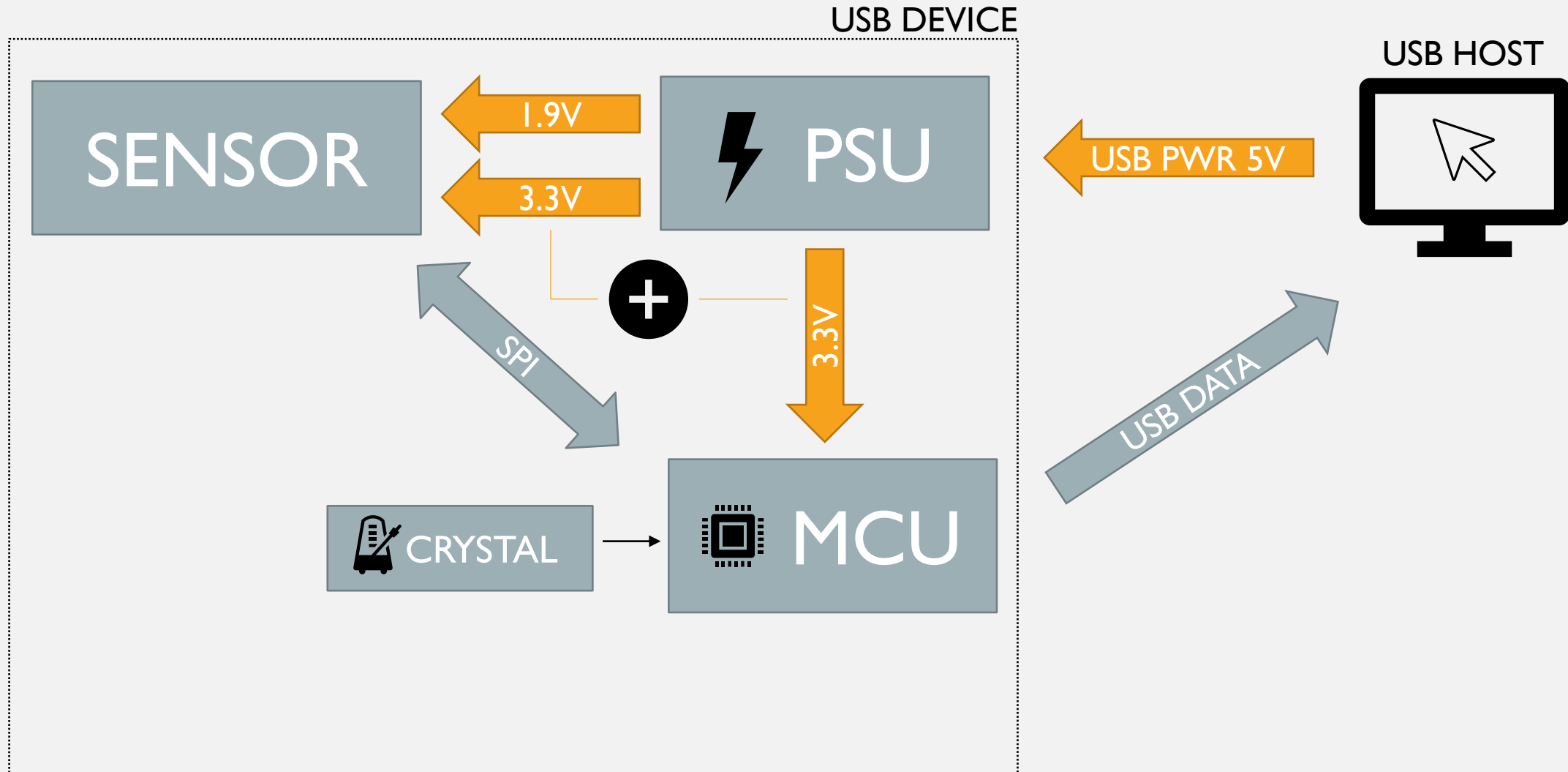
## DESTINATION

Voltage? (+/- tolerance?)  
Current draw?  
Noise?

Heat?  
Efficiency?  
Reliability?  
Space constraints?  
Cost?

# LDO

# BLOCK DIAGRAM





# OSCILLATORS

## INTERNAL (HSI/LSI)

RC OSCILLATOR  
LOW ACCURACY

## EXTERNAL (HSE/LSE)

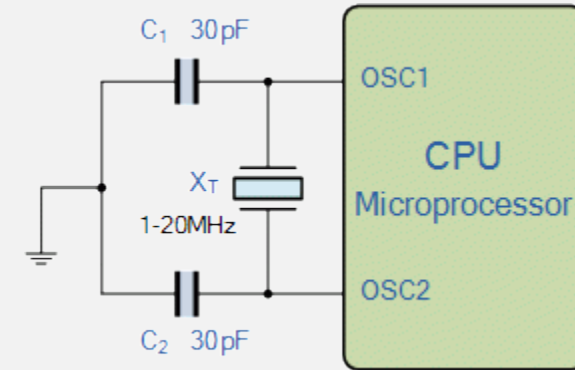
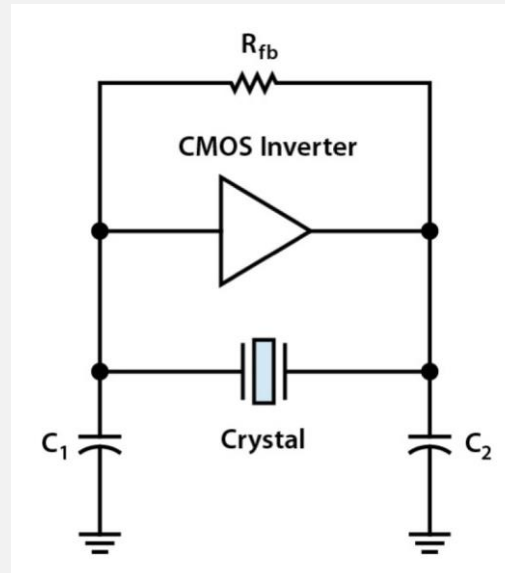
QUARTZ CRYSTAL  
HIGH ACCURACY  
TEMPERATURE STABILITY

# CRYSTAL OSCILLATOR



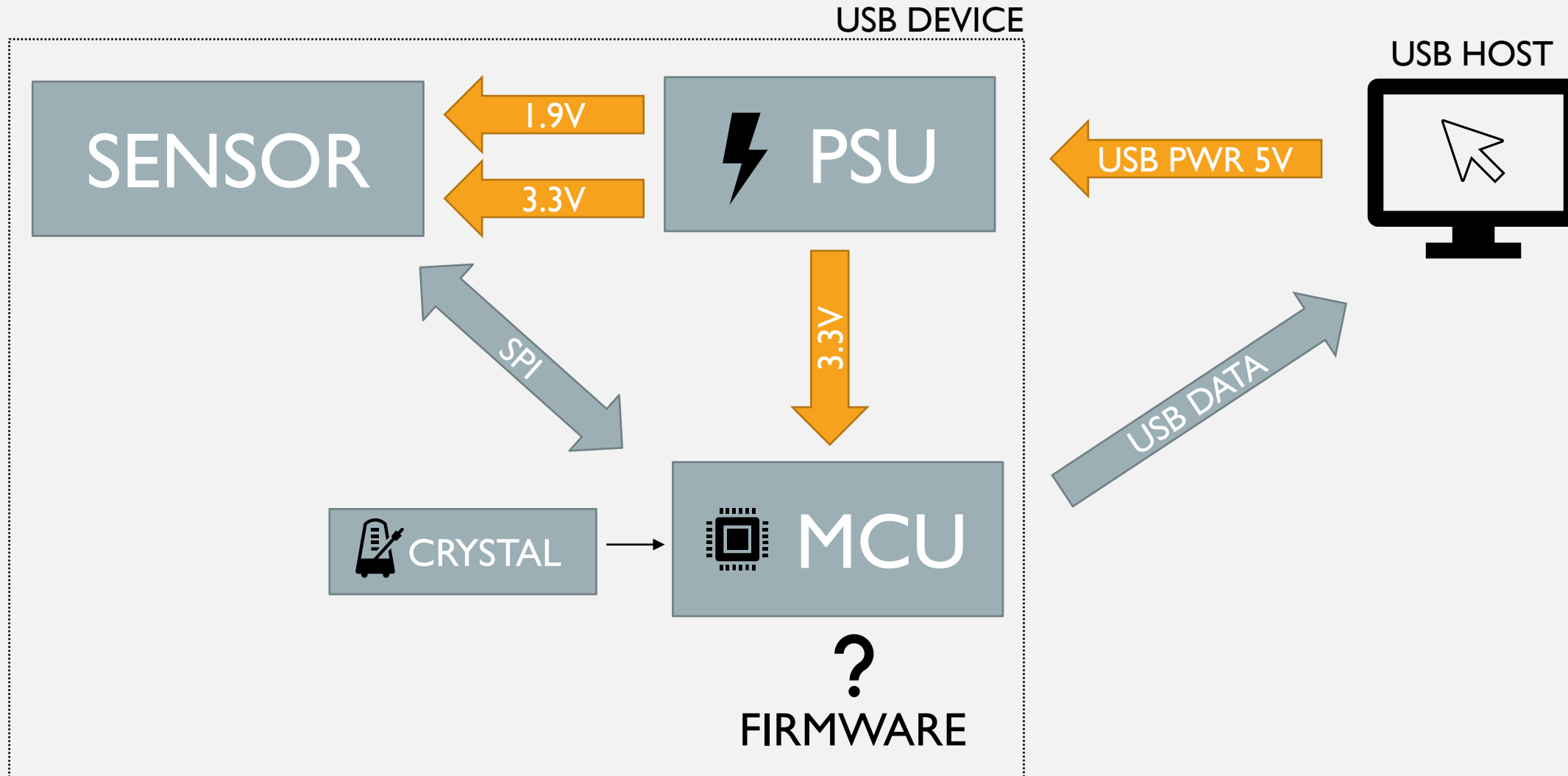
QUARTZ CRYSTAL

## PIERCE OSCILLATOR



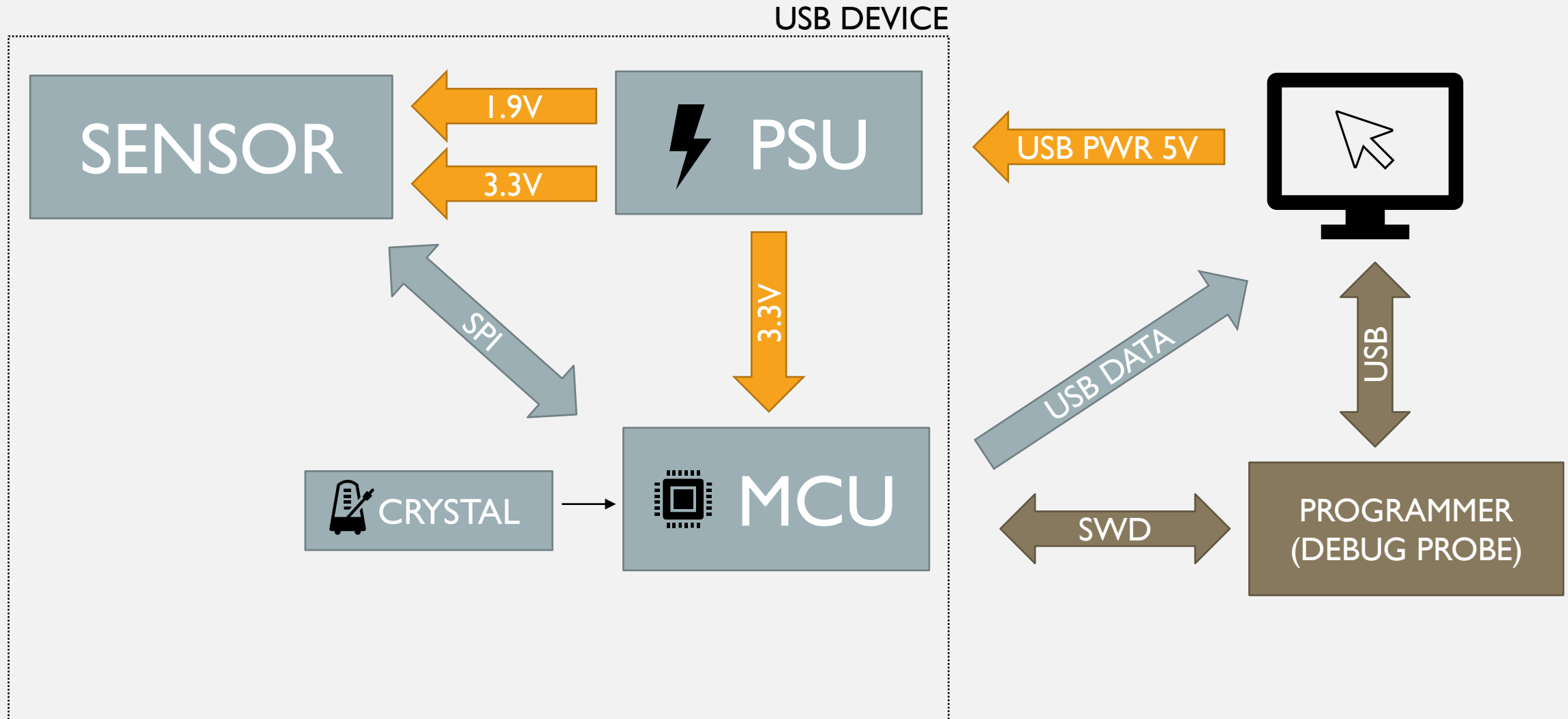
$$C1 = C2 = 2 \times (C_{load} - C_{stray})$$

# BLOCK DIAGRAM





# BLOCK DIAGRAM



## HARDWARE DESIGN PROCESS

# STM32F411

Additional connections

## NRST

Reset pin  
Active low  
Internal pull-up  
Button shorts to GND  
Bypass capacitor

## SWD

SWCLK  
SWDIO

## BOOT0

DFU mode  
Jumper to Vdd

